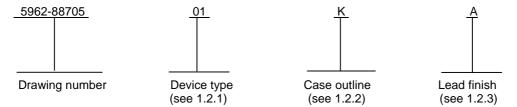
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DSCC FORM 2233
APR 97
<u>DISTRIBUTION STATEMENT A</u>. Approved for public release; distribution is unlimited.

5962-E365-03

1. SCOPE

- 1.1 <u>Scope</u>. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.
 - 1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example:



1.2.1 <u>Device types</u>. The device types identify the circuit function as follows:

Device type	Generic number	Circuit function
01	54ACT821	10-bit D-type flip-flop with three state outputs, TTL compatible inputs

1.2.2 <u>Case outlines</u>. The case outlines are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	<u>Terminals</u>	Package style
K	GDFP2-F24 or CDFP3-F24	24	Flat pack
L	GDIP3-T24 or CDIP4-T24	24	Dual-in-line
3	CQCC1-N28	28	Square leadless chip carrier

- 1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A.
- 1.3 Absolute maximum ratings. 1/ 2/

Supply voltage range (V _{CC})	0.5 V dc to +6.0 V dc maximum
DC input voltage range (V _{IN})	0.5 V dc to V _{CC} + 0.5 V dc
DC output voltage range (V _{OUT})	0.5 V dc to V_{CC} + 0.5 V dc
DC clamp current (I _{IK}) (I _{OK})	. ±20 mA
DC output current (I _{OUT})	. ±50 mA
DC V _{CC} or GND current (I _{CC} or I _{GND})	. ±100 mA
Storage temperature range (T _{STG})	65°C to +150°C
Maximum power dissipation (P _D)	. 500 mW
Lead temperature (soldering, 10 seconds)	. +300°C
Thermal resistance, junction-to-case (θ _{JC})	. See MIL-STD-1835
Junction temperature (T _J)	. +175°C 3/
	_

1.4 Recommended operating conditions. 1/

Supply voltage range (V _{CC})	. +4.5 V dc minimum to 5.5 V dc maximum
Input voltage range (V _{IN})	. 0.0 V dc to V _{CC}
Output voltage range (V _{OUT})	. 0.0 V dc to V _{CC}
Case operating temperature range (T _C)	55°C to +125°C
Input rise and fall rate ($\Delta t/\Delta V$):	
$V_{CC} = 4.5 \text{ V or } V_{CC} = 5.5 \text{ V}.$.0 to 8 ns/V

- 1/ Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.
- 2/ Unless otherwise specified, all voltages are referenced to ground.
- Maximum junction temperature shall not be exceeded except for allowable short duration burn-in screening conditions in accordance with method 5004 of MIL-STD-883.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88705
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL A	SHEET 2

2 APPLICABLE DOCUMENTS

2.1 <u>Government specification, standards, and handbooks</u>. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation.

SPECIFICATION

DEPARTMENT OF DEFENSE

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

STANDARDS

DEPARTMENT OF DEFENSE

MIL-STD-883 - Test Method Standard Microcircuits.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

HANDBOOKS

DEPARTMENT OF DEFENSE

MIL-HDBK-103 - List of Standard Microcircuit Drawings.

MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbooks are available from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

- 3.1 <u>Item requirements</u>. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.
 - 3.2.1 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.
 - 3.2.2 <u>Terminal connections</u>. The terminal connections shall be as specified on figure 1.
 - 3.2.3 Truth table. The truth table shall be as specified on figure 2.
 - 3.2.4 Logic diagram. The logic diagram shall be as specified on figure 3.
 - 3.2.5 Switching waveforms and test circuit. The switching waveforms and test circuit shall be as specified on figure 4.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88705
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL A	SHEET 3

- 3.3 <u>Electrical performance characteristics</u>. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full case operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.
- 3.5 <u>Marking</u>. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked as listed in MIL-HDBK-103 (see 6.6 herein). For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device.
- 3.5.1 <u>Certification/compliance mark</u>. A compliance indicator "C" shall be marked on all non-JAN devices built in compliance to MIL-PRF-38535, appendix A. The compliance indicator "C" shall be replaced with a "Q" or "QML" certification mark in accordance with MIL-PRF-38535 to identify when the QML flow option is used.
- 3.6 <u>Certificate of compliance</u>. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 and QML-38535 (see 6.6 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.
- 3.7 <u>Certificate of conformance</u>. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 <u>Notification of change</u>. Notification of change to DSCC-VA shall be required in accordance with MIL-PRF-38535, appendix A.
- 3.9 <u>Verification and review</u>. DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

STANDARD
MICROCIRCUIT DRAWING

DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000

SIZE A		5962-88705
	REVISION LEVEL A	SHEET 4

Test and	Symbol	Test con		Group A subgroups	Limits 2/		Unit	
MIL-STD-883 test method 1/		4.5 V ≤ V _C	$-55^{\circ}\text{C} \le T_{\text{C}} \le +125^{\circ}\text{C}$ $4.5 \text{ V} \le \text{V}_{\text{CC}} \le 5.5 \text{ V}$ unless otherwise specified		Min	Max		
High-level output voltage	V _{OH}	V _{IN} = 2.0 V or 0.8 V	$V_{CC} = 4.5 \text{ V}$	1, 2, 3	4.4		V	
3006		$I_{OH} = -50 \mu A$	$V_{CC} = 5.5 \text{ V}$	1, 2, 0	5.4		1	
	<u>3</u> /	V _{IN} = 2.0 V or 0.8 V	$V_{CC} = 4.5 \text{ V}$	-	3.7			
		$I_{OH} = -24 \text{ mA}$	$V_{CC} = 5.5 \text{ V}$		4.7			
		V _{IN} = 2.0 V or 0.8 V I _{OH} = -50 mA	$V_{CC} = 5.5 \text{ V}$		3.85			
Low-level output voltage	V _{OL}	V _{IN} = 2.0 V or 0.8 V	V _{CC} = 4.5 V	1, 2, 3		0.1	V	
3007	0/	$I_{OL} = 50 \mu A$	$V_{CC} = 5.5 \text{ V}$	1, 2, 0		0.1		
	<u>3</u> /	V _{IN} = 2.0 V or 0.8 V	$V_{CC} = 4.5 \text{ V}$			0.5		
		$I_{OL} = 24 \text{ mA}$	$V_{CC} = 5.5 \text{ V}$			0.5		
		V _{IN} = 2.0 V or 0.8 V I _{OL} = 50 mA	$V_{CC} = 5.5 \text{ V}$			1.65		
High-level input voltage	V _{IH}		V _{CC} = 4.5 V	1, 2, 3	2.0		V	
	<u>4</u> /		$V_{CC} = 5.5 \text{ V}$		2.0			
Low-level input voltage	V _{IL} <u>4</u> /		$V_{CC} = 4.5 \text{ V}$	1, 2, 3		0.8	V	
			$V_{CC} = 5.5 \text{ V}$			0.8		
Input leakage current low 3009	I _{IL}	V _{IN} = 0.0 V	V _{CC} = 5.5 V	1, 2, 3		-1.0	μΑ	
Input leakage current high 3010	Іін	V _{IN} = 5.5 V	V _{CC} = 5.5 V	1, 2, 3		1.0		
Quiescent supply current delta, TTL input levels 3005	Δl _{CC} <u>5</u> /	$V_{CC} = 5.5 \text{ V}$ For input under test, $V_{IN} = V_{CC} - 2.1 \text{ V}$ For all other inputs, $V_{IN} = V_{CC} \text{ or GND}$		1, 2, 3		1.6	mA	
Quiescent supply current	Іссн	$V_{IN} = V_{CC}$ or GND		1, 2, 3		160	μА	
3005	Iccl	$V_{CC} = 5.5 \text{ V}$		[160		
	I _{CCZ}	$I_{OUT} = 0.0 \text{ mA}$				160		
Three-state output leakage current high 3021	I _{OZH}	$\overline{\text{OE}}$ = 2.0 V or 0.0 V For all other inputs, V _{IN}	= V _{CC} or GND	1, 2, 3		10.0	μА	
Three-state output leakage current low 3020	lozL	$V_{CC} = 5.5 \text{ V}$ $V_{OUT} = 5.5 \text{ V or } 0.0 \text{ V}$				-10.0		
Input capacitance 3012	C _{IN}	See 4.3.1c		4		8.0	pF	
Power dissipation capacitance	C _{PD} <u>6</u> /	See 4.3.1c		4		95.0	pF	
Functional tests 3014		Tested at $V_{CC} = 4.5 \text{ V}$ a $V_{CC} = 5.5 \text{ V}$, see 4.3.10		7, 8	L	Н		

See footnotes at end of table.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88705
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL A	SHEET 5

	TAE	BLE I. Electrical performance characteristics	– Continued.			
Test and MIL-STD-883	Symbol	Test conditions -55°C \leq T _C \leq +125°C	Group A subgroups	Lim	Unit	
test method <u>1</u> /		$4.5 \text{ V} \le \text{V}_{CC} \le 5.5 \text{ V}$ unless otherwise specified		Min	Max	
Propagation delay time, CP to On 3003	t _{PHL} , t _{PLH} <u>7</u> /	$V_{CC} = 4.5 \text{ V}$ $C_L = 50 \text{ pF}$ $R_L = 500\Omega$ See figure 4	9, 10, 11	1.0	11.5	ns
Propagation dela <u>y ti</u> me, output enable, OE to On 3003	t _{PZH} , t _{PZL} <u>7</u> /		9, 10, 11	1.0	13.0	
Propagation delay time, output disable, OE to On 3003	t _{PHZ} , t _{PLZ} <u>7</u> /		9, 10, 11	1.0	13.5	
Maximum frequency	f _{MAX}		9, 10, 11	85		MHz
Pulse width, CP	t _w		9, 10, 11	6.0		ns
Minimum set-up time, Dn to CP	ts		9	3.5 4.0		
Minimum hold time, Dn to CP	t _h		9	2.5		1

- 1/ For tests not listed in the referenced MIL-STD-883 (e.g. ΔI_{CC}), utilize the general test procedure under the conditions listed herein. All inputs and outputs shall be tested, as applicable, to the tests in table I herein.
- 2/ For negative and positive voltage and current values, the sign designates the potential difference in reference to GND and the direction of current flow, respectively; and the absolute value of the magnitude, not the sign, is relative to the minimum and maximum limits, as applicable, listed herein.
- $3/V_{OH}$ and V_{OL} shall be tested at V_{CC} = 4.5 V. V_{OH} and V_{OL} are guaranteed, if not tested, for V_{CC} = 5.5 V. Limits shown apply to operation at V_{CC} = 5.0 V \pm 0.5 V. Transmission driving tests are performed at V_{CC} = 5.5 V with a 2 ms duration maximum.
- $\underline{4}$ / V_{IH} and V_{IL} tests are not required, and shall be applied as forcing functions for V_{OH} and V_{OL} tests.
- This test may be performed either one input at a time (preferred method) or with all input pins simultaneously at $V_{IN} = V_{CC}$ 2.1 V (alternate method). Classes Q and V shall use the preferred method. When the test is performed using the alternate test method, the maximum limits are equal to the number of inputs at a high TTL input level times 1.6 mA; and the preferred method and limits are guaranteed.
- 6/ Power dissipation capacitance (C_{PD}) determines the no load dynamic power consumption, P_D = (C_{PD} + C_L) (V_{CC} x V_{CC})f + (I_{CC} x V_{CC}) + (n x d x ΔI_{CC} x V_{CC}). The dynamic current consumption, I_S = (C_{PD} + C_L)V_{CC}f + I_{CC} + n x d x ΔI_{CC}. For both P_D and I_S, n is the number of device inputs at TTL levels, f is the frequency of the input signal, and d is the duty cycle of the input signal.
- $\underline{7}$ / AC limits at V_{CC} = 5.5 V are equal to limits at V_{CC} = 4.5 V and guaranteed by testing at V_{CC} = 4.5 V. The minimum ac limits are guaranteed for V_{CC} = 5.5 V by guardbanding the V_{CC} = 4.5 V limits to 1.5 ns minimum.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88705
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL A	SHEET 6

Device type	01		
Case outlines	K and L	3	
Terminal number	Terminal symbol		
1	E	NC	
2	D0	OE	
3	D1	D0	
4	D2	D1	
5	D3	D2	
6	D4	D3	
7	D5	D4	
8	D6	NC	
9	D7	D5	
10	D8	D6	
11	D9	D7	
12	GND	D8	
13	CP	D9	
14	O9	GND	
15	O8	NC	
16	07	CP	
17	O6	O9	
18	O5	08	
19	04	07	
20	O3	O6	
21	O2	O5	
22	01	NC	
23	O0	O4	
24	V _{CC}	O3	
25		O2	
26		O1	
27		00	
28		V _{CC}	

NC = No connection

FIGURE 1. <u>Terminal connections</u>.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88705
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL A	SHEET 7

	Inputs		Outputs	Function
ŌE	CP	Dn	On	
Н	1	L	Z	High impedance
Н	1	Н	Z	High impedance
L	\uparrow	L	L	Load
L	1	Н	Н	Load

H = High voltage level
 L = Low voltage level
 Z = High impedance
 ↑ = Low to high transition of the clock

FIGURE 2. Truth table.

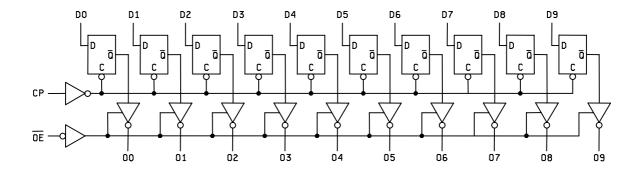
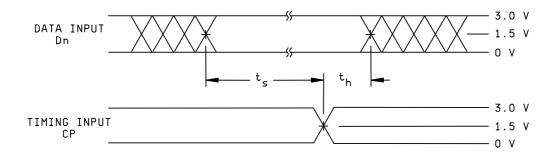


FIGURE 3. Logic diagram.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88705
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL A	SHEET 8



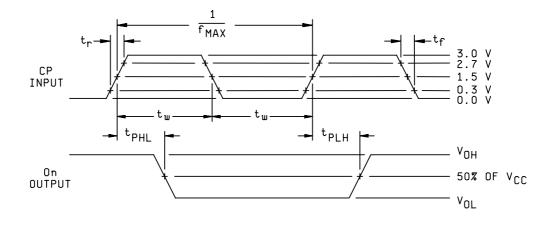
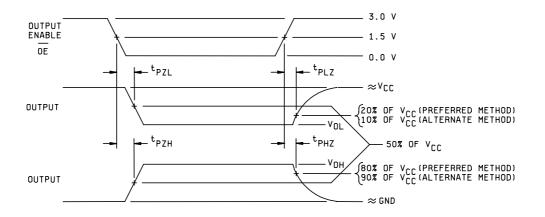
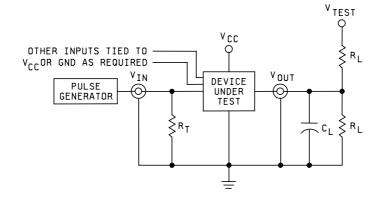


FIGURE 4. Switching waveforms and test circuit.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88705
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL A	SHEET 9





NOTES:

1. Preferred method:

When measuring t_{PHZ} and t_{PZH}: V_{TEST} = GND When measuring t_{PLZ} and t_{PZL}: V_{TEST} = 2 X V_{CC} When measuring t_{PLH} and t_{PHL}: V_{TEST} = open Alternate method:

When measuring t_{PLZ} and t_{PZL} : $V_{TEST} = 2 X V_{CC}$

When measuring t_{PHZ} , t_{PZH} , t_{PLH} , and t_{PHL} : V_{TEST} = open

- 2. C_L = 50 pF minimum or equivalent (includes test jig and probe capacitance).
- 3. $R_T=50\Omega$ or equivalent. $R_L=500\Omega$ or equivalent.
- 4. Input signal from pulse generator: $V_{IN} = 0.0 \text{ V}$ to 3.0 V; PRR \leq 10 MHz; $t_r \leq$ 3 ns; $t_f \leq$ 3 ns;
- 5. Timing parameters shall be tested at a minimum input frequency of 1 MHz.
- 6. Outputs are measured one at a time with one output per measurement.

FIGURE 4. Switching waveforms and test circuit - Continued

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88705
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL A	SHEET 10

4. QUALITY ASSURANCE PROVISIONS

- 4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.
- 4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
 - a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}C$, minimum.
 - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.
- 4.3 <u>Quality conformance inspection</u>. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
 - 4.3.1 Group A inspection.
 - a. Tests shall be as specified in table II herein.
 - b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
 - c. Subgroup 4 (C_{IN} and C_{PD} measurements) shall be measured only for the initial test and after process or design changes which may affect input capacitance. Test all applicable pins on 5 devices with zero failures.
 - d. Subgroup 7 and 8 shall verify the truth table as specified in figure 2 herein.
 - 4.3.2 Groups C and D inspections.
 - a. End-point electrical parameters shall be as specified in table II herein.
 - b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}C$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88705
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL A	SHEET 11

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)
Interim electrical parameters (method 5004)	
Final electrical test parameters (method 5004)	<u>1</u> / 1, 2, 3, 7, 8, 9, 10, 11
Group A test requirements (method 5005)	1, 2, 3, 4, 7, 8, 9, 10, 11
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

1/ PDA applies to subgroup 1.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.

6. NOTES

- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.
- 6.2 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.
- 6.4 <u>Record of users</u>. Military and industrial users shall inform Defense Supply Center Columbus when a system application requires configuration control and the applicable SMD. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0544.
- 6.5 <u>Comments</u>. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43216-5000, or telephone (614) 692-0547.
- 6.6 <u>Approved sources of supply</u>. Approved sources of supply are listed in MIL-HDBK-103 and QML-38535. The vendors listed in MIL-HDBK-103 and QML-38535 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88705
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL A	SHEET 12

STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 03-06-10

Approved sources of supply for SMD 5962-88705 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535.

Standard microcircuit drawing PIN <u>1</u> /	Vendor CAGE number	Vendor similar PIN <u>2</u> /
5962-8870501KA	27014	54ACT821FMQB
5962-8870501LA	27014	54ACT821DMQB
5962-88705013A	27014	54ACT821LMQB

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the Vendor to determine its availability.
- <u>2</u>/ <u>Caution</u>. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance re]\quirements of this drawing.

Vendor CAGE <u>number</u>

27014

Vendor name and address

National Semiconductor 2900 Semiconductor Drive P.O. Box 58090 Santa Clara, CA 95052-8090

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